80SQ045N

Preferred Device

Axial Lead Rectifier

...employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- High Current Capability
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Stress Protection
- Low Forward Voltage
- High Surge Capacity

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 500 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	45	V
Average Rectified Forward Current T _L = 75°C (Psi _{JL} = 12°C/W, P.C. Board Mounting, see Note 2.)	lo	8.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	140	A
Operating and Storage Junction Temperature Range (Reverse Voltage Applied)	T _J , T _{stg}	-65 to +125	°C
Voltage Rate of Change (Rated V _R)	dv/dt	10	V/ns



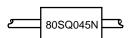
ON Semiconductor™

http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 8.0 AMPERES



MARKING DIAGRAM



80SQ045N= Device Code

ORDERING INFORMATION

Device	Package	Shipping	
80SQ045N	Axial Lead	500 Units/Bag	
80SQ045NRL	Axial Lead	1500/Tape & Reel	

Preferred devices are recommended choices for future use and best overall value.

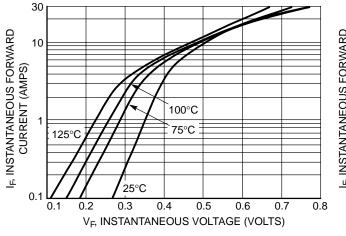
THERMAL CHARACTERISTICS

Characteristic	Symbol	0.9 in x 0.9 in Copper Pad Size	6.75 in x 6.75 in Copper Pad Size	Unit
Thermal Resistance – Junction–to–Lead (See Note 2. – Mounting Data)	$R_{\theta JL}$	13	12	°C/W
Thermal Resistance – Junction–to–Ambient (See Note 2. – Mounting Data)	$R_{\theta JA}$	50	40	

ELECTRICAL CHARACTERISTICS (T_L = 25°C unless otherwise noted)

Characteristic		Max	Unit
Maximum Instantaneous Forward Voltage (Note 1.)	VF		V
$(i_F = 8.0 \text{ Amps}, T_L = 25^{\circ}\text{C})$		0.55	
Maximum Instantaneous Reverse Current @ Rated dc Voltage (Note 1.)	i _R		mA
$T_L = 25^{\circ}C$		1.0	
$T_L = 100$ °C		50	

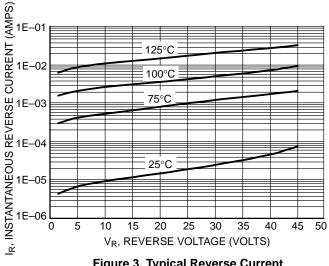
^{1.} Pulse Test: Pulse Width = $300 \mu s$, Duty Cycle = 2.0%.



30 I_F INSTANTANEOUS FORWARD CURRENT (AMPS) 10 MBR845 100°C 75°C 25°C 0.1 0.1 0.4 V_F, INSTANTANEOUS VOLTAGE (VOLTS)

Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage



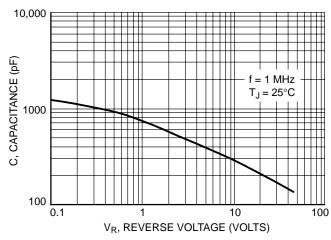


Figure 3. Typical Reverse Current

Figure 4. Typical Capacitance

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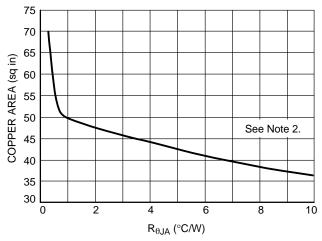


Figure 5. $R_{\theta JA}$ versus Copper Area

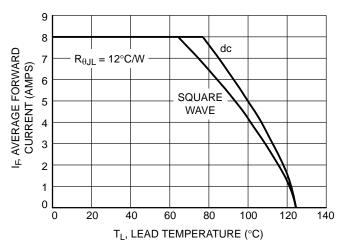


Figure 6. Current Derating - Lead

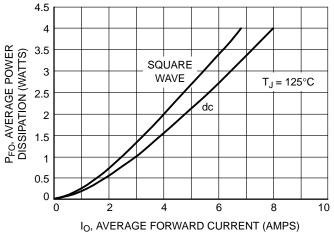
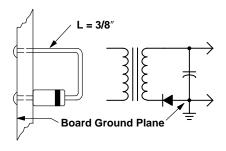


Figure 7. Forward Power Dissipation

NOTE 2. — MOUNTING DATA

Mounting Method

P.C. Board with 6.75 sq. in. copper surface.



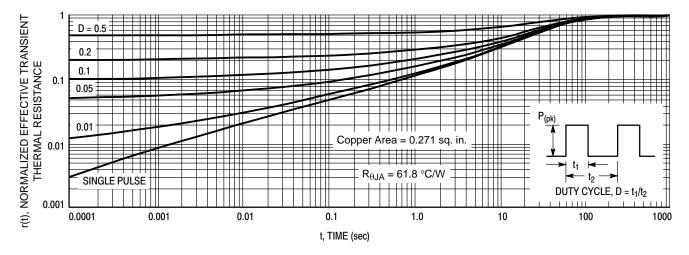


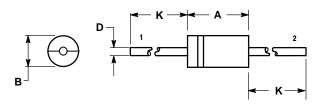
Figure 8. Thermal Response, Junction-to-Ambient

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PACKAGE DIMENSIONS

AXIAL LEAD

CASE 267-03 ISSUE G



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
 Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.

	INCHES		INCHES N		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX		
Α	0.370	0.380	9.40	9.65		
В	0.190	0.210	4.83	5.33		
D	0.048	0.052	1.22	1.32		
K	1.000		25.40			

STYLE 1

PIN 1. CATHODE (POLARITY BAND) 2. ANODE

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